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Kind regards,

Team Nexperia



BC847DS 45 V, 100 mA NPN/NPN general-purpose transistorRev. 01 — 25 August 2009Production

Product data sheet

Product profile 1.

1.1 General description

NPN/NPN general-purpose transistor pair in a small SOT457 (SC-74) Surface-Mounted Device (SMD) plastic package.

1.2 Features

- Low collector capacitance
- Low collector-emitter saturation voltage
- Closely matched current gain
- Reduces number of components and board space
- No mutual interference between the transistors
- AEC-Q101 qualified

1.3 Applications

General-purpose switching and amplification

1.4 Quick reference data

Quick reference data Table 1.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Per trans	istor					
V _{CEO}	collector-emitter voltage	open base	-	-	45	V
I _C	collector current		-	-	100	mA
h _{FE}	DC current gain	V_{CE} = 5 V; I_C = 2 mA	200	300	450	



45 V, 100 mA NPN/NPN general-purpose transistor

2. Pinning information

Table 2.	Pinning		
Pin	Description	Simplified outline	Graphic symbol
1	emitter TR1		
2	base TR1		
3	collector TR2	0	
4	emitter TR2		
5	base TR2		
6	collector TR1		1 2 3
			sym020

3. Ordering information

Table 3. Order	ring inform	ation	
Type number	Package		
	Name	Description	Version
BC847DS	SC-74	plastic surface-mounted package (TSOP6); 6 leads	SOT457

4. Marking

Table 4.	Marking codes	
Type num	ber	Marking code
BC847DS		ZL

5. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
Per transis	tor				
V _{CBO}	collector-base voltage	open emitter	-	50	V
V _{CEO}	collector-emitter voltage	open base	-	45	V
V _{EBO}	emitter-base voltage	open collector	-	6	V
I _C	collector current		-	100	mA
I _{CM}	peak collector current	single pulse; $t_p \leq 1 ms$	-	200	mA
I _{BM}	peak base current	single pulse; $t_p \leq 1 ms$	-	200	mA
P _{tot}	total power dissipation	$T_{amb} \le 25 \ ^{\circ}C$	<u>[1]</u> _	250	mW
Per device					
P _{tot}	total power dissipation	$T_{amb} \leq 25 \ ^{\circ}C$	<u>[1]</u> -	380	mW

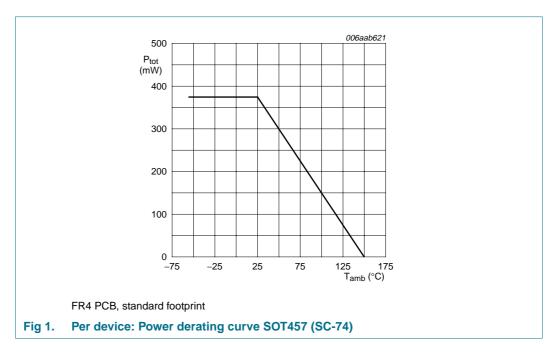
45 V, 100 mA NPN/NPN general-purpose transistor

Table 5. Limiting values ...continued

In accordance with the Absolute Maximum Rating System (IEC 60134).

			-		
Symbol	Parameter	Conditions	Min	Max	Unit
Тj	junction temperature		-	150	°C
T _{amb}	ambient temperature		-55	+150	°C
T _{stg}	storage temperature		-65	+150	°C

[1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard footprint.



6. Thermal characteristics

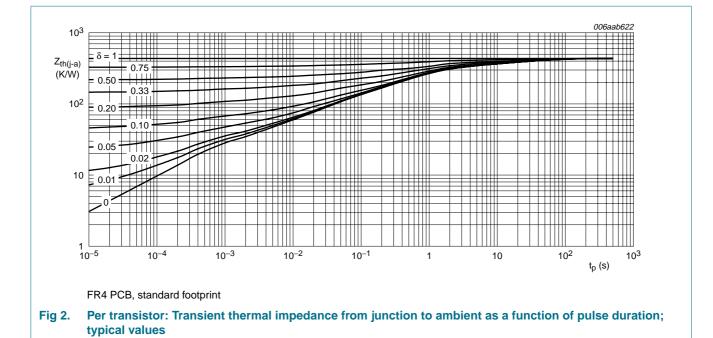
Table 6.	Thermal characteristics					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Per trans	istor					
R _{th(j-a)}	thermal resistance from junction to ambient	in free air	<u>[1]</u> -	-	500	K/W
R _{th(j-sp)}	thermal resistance from junction to solder point		-	-	250	K/W
Per devic	e					
R _{th(j-a)}	thermal resistance from junction to ambient	in free air	<u>[1]</u> -	-	328	K/W

[1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

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BC847DS

45 V, 100 mA NPN/NPN general-purpose transistor



7. Characteristics

Table 7.Characteristics

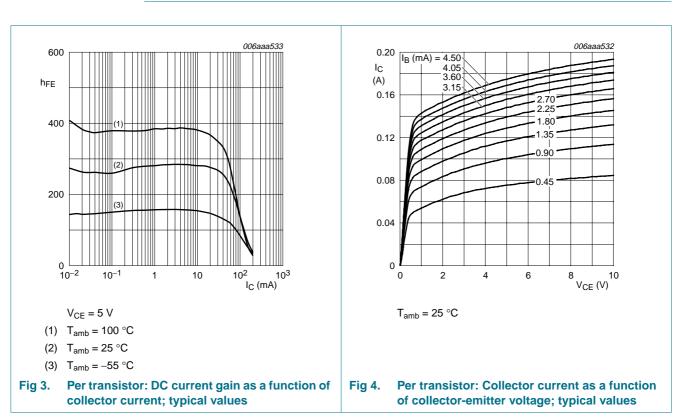
 $T_{amb} = 25 \circ C$ unless otherwise specified.

Symbol	Parameter	Conditions	Min	Тур	Мах	Unit
Per trans	sistor					
I _{CBO}	collector-base cut-off	$V_{CB} = 30 \text{ V}; I_E = 0 \text{ A}$	-	-	15	nA
	current	$V_{CB} = 30 \text{ V}; I_E = 0 \text{ A};$ $T_j = 150 \text{ °C}$	-	-	5	μA
I _{EBO}	emitter-base cut-off current	$V_{EB} = 6 V; I_C = 0 A$	-	-	100	nA
h _{FE}	DC current gain	$V_{CE} = 5 V$				
		I _C = 10 μA	-	280	-	
		$I_{\rm C} = 2 \rm mA$	200	300	450	
V _{CEsat}	collector-emitter	$I_{C} = 10 \text{ mA}; I_{B} = 0.5 \text{ mA}$	-	55	100	mV
	saturation voltage	I _C = 100 mA; I _B = 5 mA	-	200	300	mV
V _{BEsat}	base-emitter	$I_{C} = 10 \text{ mA}; I_{B} = 0.5 \text{ mA}$	-	755	850	mV
	saturation voltage	I _C = 100 mA; I _B = 5 mA	-	1000	-	mV
V _{BE}	base-emitter voltage	$V_{CE} = 5 V$				
		$I_{\rm C} = 2 \rm mA$	580	650	700	mV
		I _C = 10 mA	-	-	770	mV

45 V, 100 mA NPN/NPN general-purpose transistor

' amb - 20	⁵ ^c unless otherwise s					
Symbol	Parameter	Conditions	Min	Тур	Мах	Unit
C _c	collector capacitance	$V_{CB} = 10 \text{ V}; \text{ I}_{E} = \text{i}_{e} = 0 \text{ A};$ f = 1 MHz	-	1.9	-	pF
C _e	emitter capacitance	$\label{eq:Veb} \begin{split} V_{EB} &= 0.5 \text{ V}; \text{ I}_{C} = \text{i}_{c} = 0 \text{ A}; \\ \text{f} &= 1 \text{ MHz} \end{split}$	-	11	-	pF
f _T	transition frequency	$V_{CE} = 5 \text{ V}; I_C = 10 \text{ mA};$ f = 100 MHz	100	-	-	MHz
NF	noise figure		-	1.9	-	dB
		$V_{CE} = 5 \text{ V}; I_C = 0.2 \text{ mA};$ $R_S = 2 \text{ k}\Omega; f = 1 \text{ kHz};$ B = 200 Hz	-	3.1	-	dB

Characteristics ... continued Table 7.

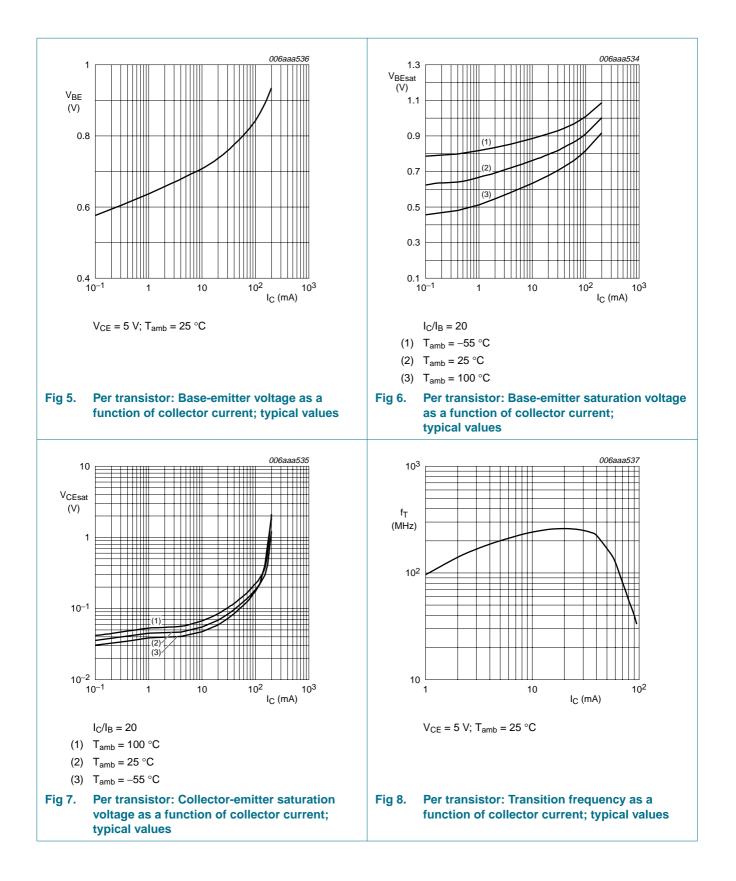


$T_{omb} = 25 \,^{\circ}C$ unless otherwise specified

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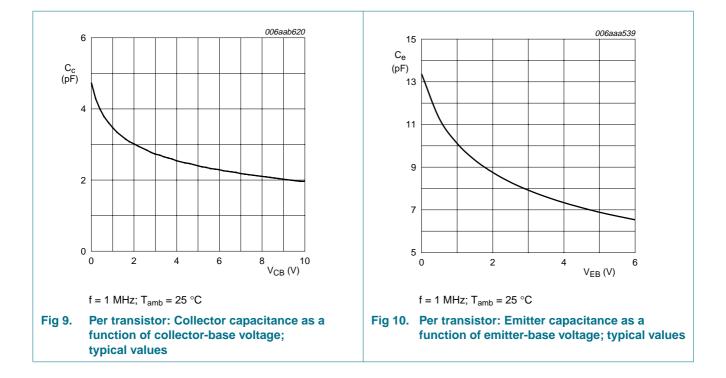
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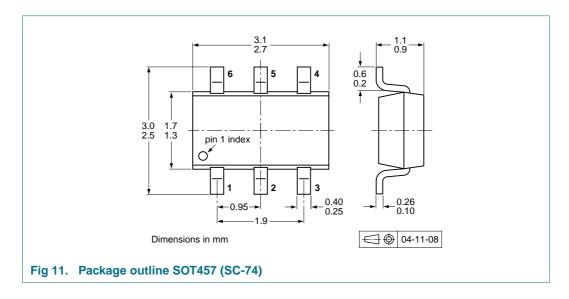
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8. Test information

8.1 Quality information

This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard *Q101* - *Stress test qualification for discrete semiconductors*, and is suitable for use in automotive applications.

9. Package outline



10. Packing information

Table 8. Packing methods

The indicated -xxx are the last three digits of the 12NC ordering code.[1]

Type number	number Package Description			Packing	quantity
				3000	10000
BC847DS	SOT457	4 mm pitch, 8 mm tape and reel; T1	[2]	-115	-135
		4 mm pitch, 8 mm tape and reel; T2	<u>[3]</u>	-125	-165

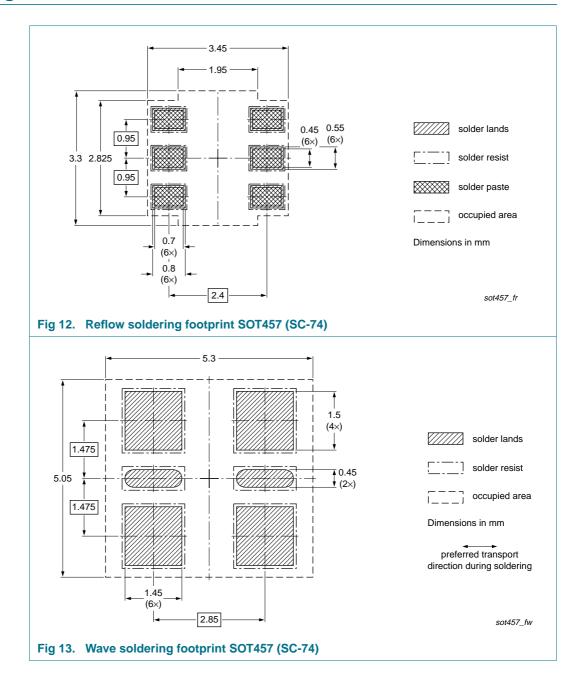
[1] For further information and the availability of packing methods, see <u>Section 14</u>.

[2] T1: normal taping

[3] T2: reverse taping

45 V, 100 mA NPN/NPN general-purpose transistor

11. Soldering



45 V, 100 mA NPN/NPN general-purpose transistor

12. Revision history

Table 9. Revis	Revision history				
Document ID	Release date	Data sheet status	Change notice	Supersedes	
BC847DS_1	20090825	Product data sheet	-	-	

13. Legal information

13.1 Data sheet status

Document status[1][2]	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.nxp.com.

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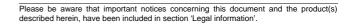
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BC847DS_1 Product data sheet

45 V, 100 mA NPN/NPN general-purpose transistor

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